

1.6X1.26mm SMD CHIP LED LAMP



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE **DEVICES**

Part Number: KPHF-1612QBDSURKZGC

Blue Hyper Red Green

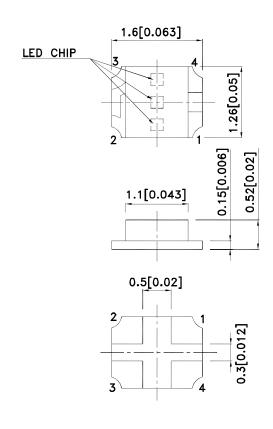
Features

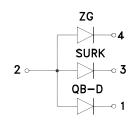
- 1.6x1.26mm SMT LED, 0.52mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

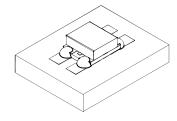
Descriptions

- The Blue source color devices are made with InGaN Light Emitting Diode.
- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode.
- Electrostatic discharge and power surge could damage the LEDs.
- It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipments and machineries must be electrically grounded.

Package Dimensions







- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.2(0.008") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide							
Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]		
		3,11	Min.	Тур.	201/2		
KPHF-1612QBDSURKZGC	Blue (InGaN)	Water Clear	40	70	120°		
			*40	*70			
	Hyper Red (AlGaInP)		120	200			
			*40	*80			
	Green (InGaN)		120	280			
			*120	*280			

Notes:

- 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
- Luminous intensity/ luminous Flux: +/-15%.
 Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Blue Hyper Red Green	460 645 515		nm	IF=20mA
λD [1]	Dominant Wavelength	Blue Hyper Red Green	465 630 525		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Blue Hyper Red Green	25 28 30		nm	IF=20mA
С	Capacitance	Blue Hyper Red Green	100 35 45		pF	VF=0V;f=1MHz
VF [2]	Forward Voltage	Blue Hyper Red Green	3.3 1.95 3.3	4 2.5 4.1	V	IF=20mA
lr	Reverse Current	Blue Hyper Red Green		50 10 50	uA	VR=5V

Notes:

- 1.Wavelength: +/-1nm.
 2. Forward Voltage: +/-0.1V.
- 3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

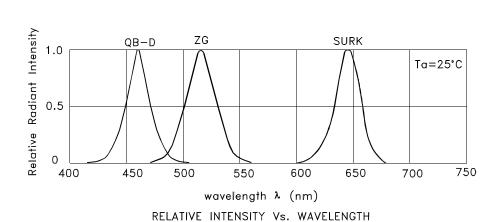
Absolute Maximum Ratings at TA=25°C

Parameter	Blue	Hyper Red	Green	Units	
Power dissipation	120	75	102.5	mW	
DC Forward Current	30	30	25	mA	
Peak Forward Current [1]	150	185	150	mA	
Reverse Voltage		V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

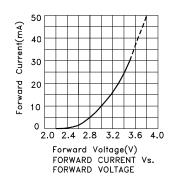
Notes:

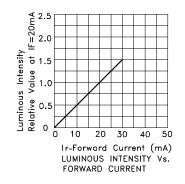
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

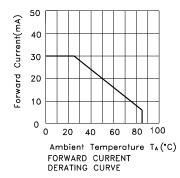
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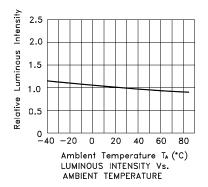


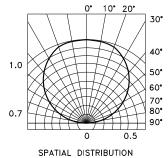
KPHF-1612QBDSURKZGC Blue







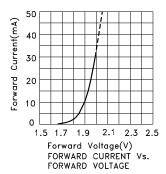


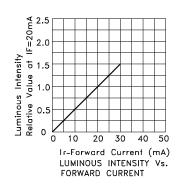


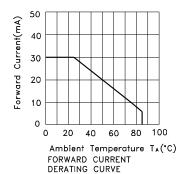
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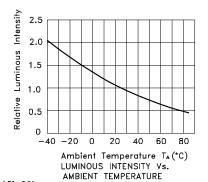
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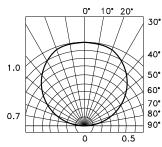
Hyper Red









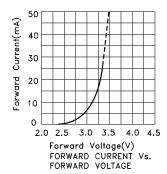


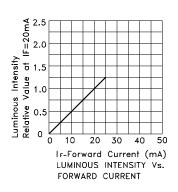
SPATIAL DISTRIBUTION

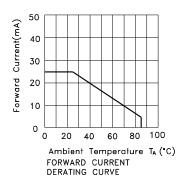
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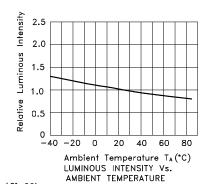
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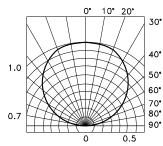
Green











SPATIAL DISTRIBUTION

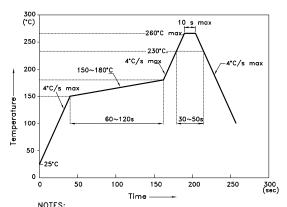
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



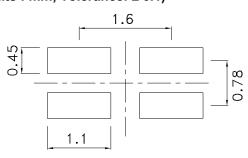
- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- to high temperature.

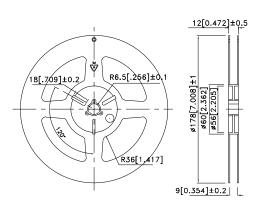
 3.Number of reflow process shall be 2 times or less.

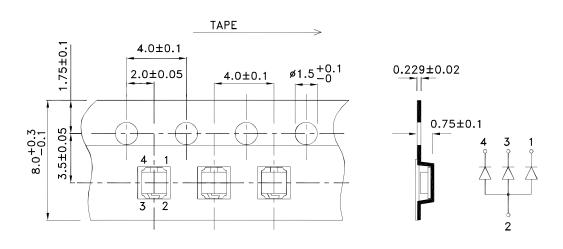
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

Reel Dimension

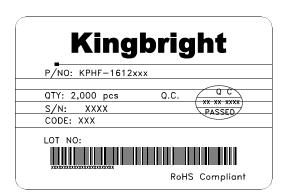




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PACKING & LABEL SPECIFICATIONS USER DIRECTION OF FEED 1 REEL / BAG OUTSIDE LABEL Kingbright Kingbright



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